

Crystal Growth: Physics, Technology and Modeling

Stanisław Krukowski & Michał Leszczyński Institute of High Pressure Physics PAS 01-142 Warsaw, Sokołowska 29/37

e-mail: stach@unipress.waw.pl, mike@unipress.waw.pl

Zbigniew R. Żytkiewicz

Institute of Physics PAS
02-668 Warsaw, Al. Lotników 32/46
E-mail: zytkie@ifpan.edu.pl

Lecture 5. MBE of nitride semiconductors

22 March 2022

http://www.unipress.waw.pl/~stach/cg-2021-22



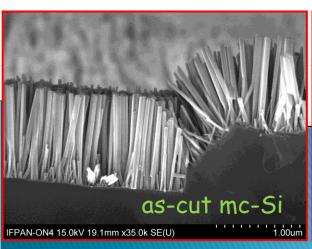


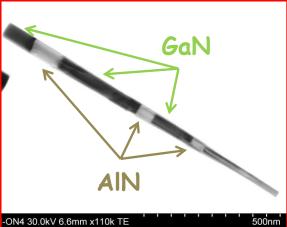
Zbigniew R. Zytkiewicz

Institute of Physics, Polish Academy of Sciences Al. Lotnikow 32/46, 02-668 Warszawa

Group of MBE Growth of Nitride Nanostructures

http://info.ifpan.edu.pl/Dodatki/WordPress/mbe2en/





zytkie@ifpan.edu.pl

Molecular beam epitaxy of nitride semiconductors



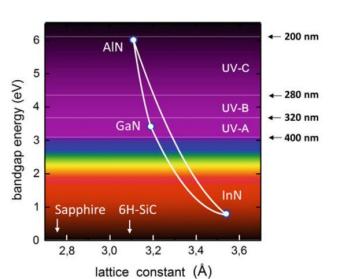
Outline

- 1. Introduction
- 2. Overview of surface processes during crystal growth
- 3. Specific case MBE of nitride semiconductors, How surface phenomena can be observed *in situ by*:
 - Reflection High Energy Electron Diffraction (RHEED)
 - Laser Reflectometry (LR)
 - line-of-sight Quadrupole Mass Spectroscopy (QMS)
 - What atoms do on the surface?
- 4. PAMBE growth of GaN nanowires
- 5. Summary

Why nitride semiconductors?

(Al, Ga, In)N:





- very broad range of E_q (InN 0.7 eV AIN 6 eV)
 - the only one material system that covers so large E_a range
- resistant to main chemicals and high temperature (applications in harsh environment)
- large breakdown voltage (GaN 3×10^6 V/cm) high power
 - electronics
 - good thermal conductivity



High power/RF electronics

Solid State Lighting





UV Lithography



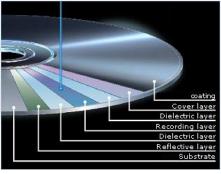
Medical treatment



High resolution printing



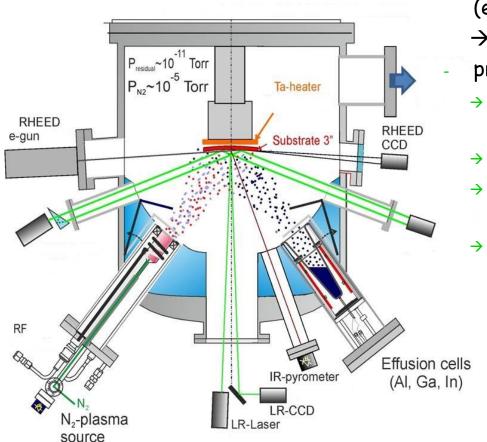
Water processing



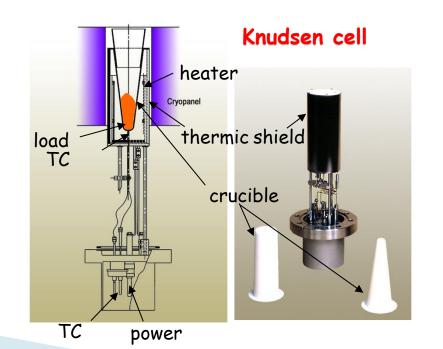
Data storage

What Molecular Beam Epitaxy (MBE) means?





- very low residual gas pressure ~10⁻¹¹ Tr (efficient UHV pumps and LN₂ filled cryopanel)
- \rightarrow high purity of crystals (low doping) pressure inside the beam ~10⁻⁵ 10⁻⁶ Tr
- mean free path of species inside the beam
 m >> source substrate distance
- ballistic flow of species; shadowing effect
- growth environment transparent for light,
 X-rays, e-beam, etc.
- > many in-situ diagnostic tools available



Nitrogen sources in nitride MBE

PAN

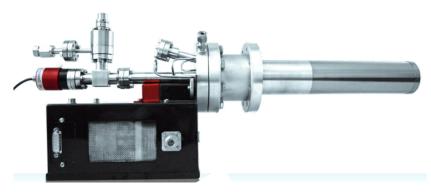
N₂ molecule very stable and chemically inactive \otimes

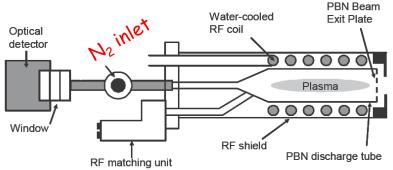
ammonia (NH₃) MBE

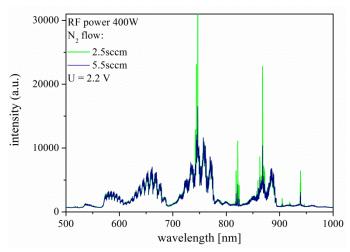
gas NH₃ injector

thermal cracking of NH_3 molecule at the hot substrate surface; N atoms and hydrogen released; requires high growth temperature (usually ~900 - $1000^{\circ}C$); similar mechanism as in MOVPE

plasma-assisted MBE (PAMBE)







optical spectroscopy of nitrogen plasma in the RF cavity

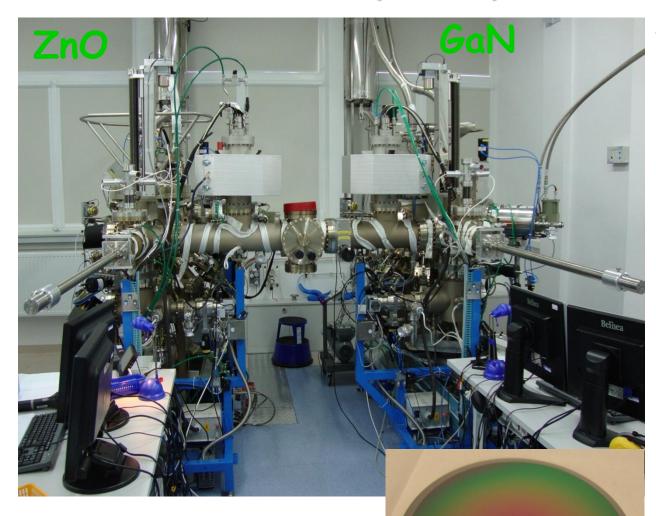
nitrogen plasma emits atomic N and excited N_2^* species;

MBE growth at much lower T possible

K. Klosek et al. Thin Solid Films 534 (2013) 107

Plasma-Assisted MBE (PAMBE) Riber Compact 21





growth on 3" substrates

TOOLS:

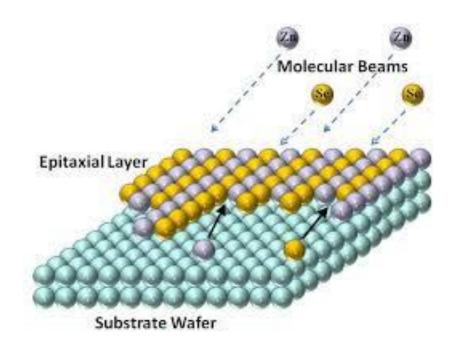
- optical pyrometer
- RHEED (k-Space)
- laser reflectometry
- LayTec EpiCurve TT (temperature, wafer curvature)
- line-of-sight quadrupole mass spectrometry (QMS)

SOURCES:

- ▶ Ga x2
- Al x2
- In
- RF nitrogen source
- ▶ 5i x2
- Mg
- Fe

Crystal growth by MBE





crystal growth = two step process

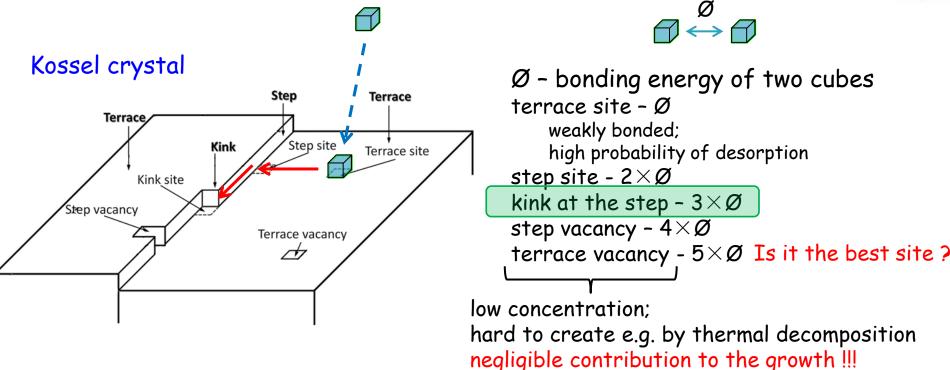
- 1. bulk material transport towards the growth interface
- 2. surface phenomena

As always in two-step processes, the slowest step determines the overall growth kinetics

Usually (for sure in MBE (9)) the growth kinetics is limited by the rate of surface processes

How crystals grow? Surface phenomena





most effective - kinks at the steps operative if atoms (adatoms) are mobile enough on the surface

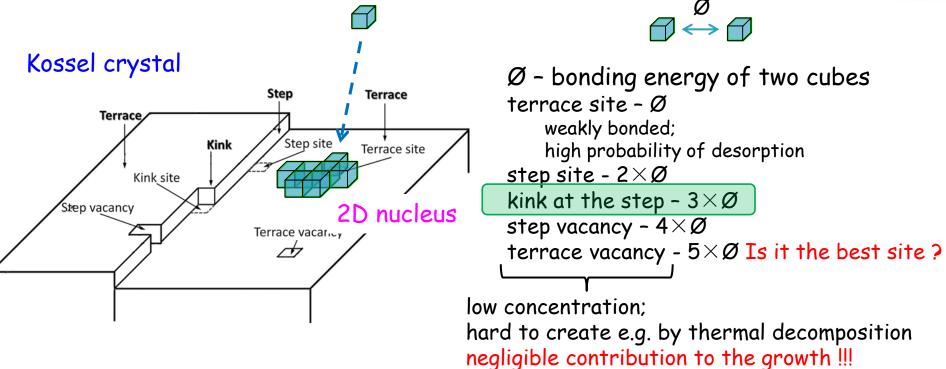
step-flow if the mean diffusion length

$$L_{diff} = \sqrt{D \times \tau} > terrace \ width$$

diffusion coefficient lifetime on the surface

How crystals grow? Surface phenomena





most effective - kinks at the steps operative if atoms (adatoms) are mobile on the surface

step-flow if the mean diffusion length

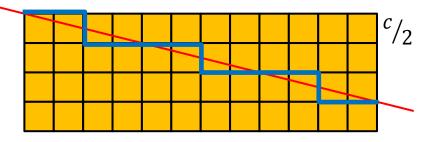
$$L_{diff} = \sqrt{D \times \tau} > terrace\ width$$

otherwise – 2D nuclei form and island growth takes place (2D nuclei stable if larger than critical size)

Sources of surface steps

PAN

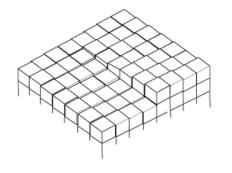
surface miscut

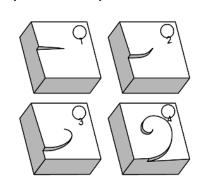


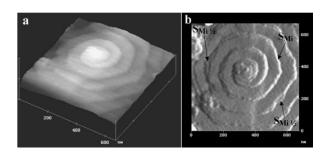
lecture #2 by prof. M. Boćkowski steps formed intentionally by surface miscut

$$L_{terrace} = c/2 tg(\alpha)$$

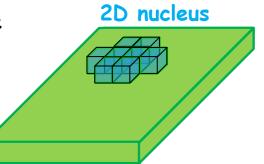
screw dislocations on flat surface







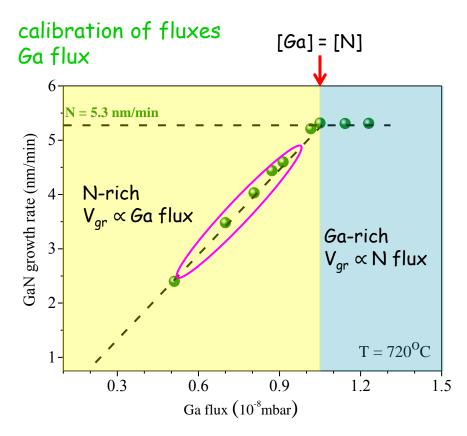
2D nuclei on perfect, flat surface





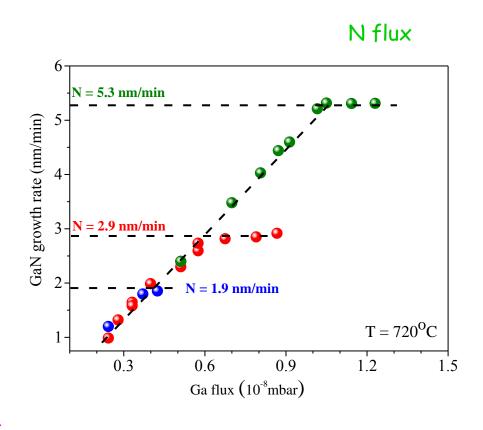
Surface steps are always present on the surface





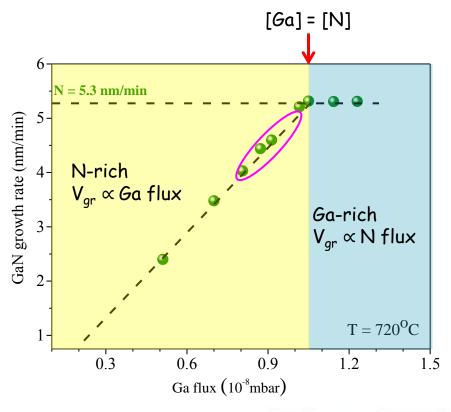


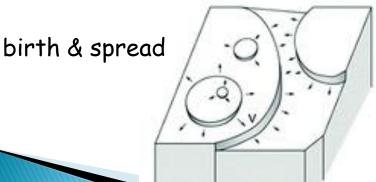
- overpressure of volatile group V species
- metal flux controls growth rate



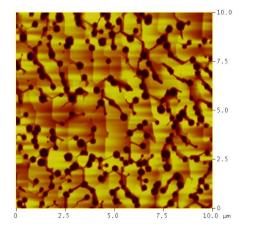
Ga flux = 3 nm/min → Ga flux that under N-rich conditions and low T (no Ga desorption) would cause GaN growth with the rate of 3 nm/min





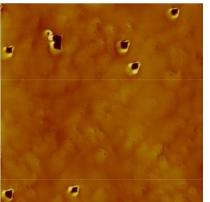


AFM image of epilayer surface $(10 \times 10 \mu m^2 \text{ area})$



$$T_{growth} = 720$$
°C

 $rms = 18.3 \, nm$



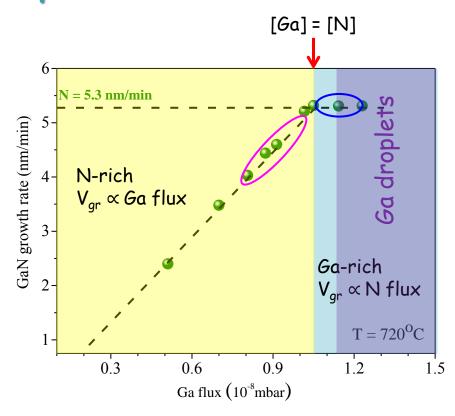
$$T_{growth} = 770^{\circ}C$$

rms = 3.2 nm

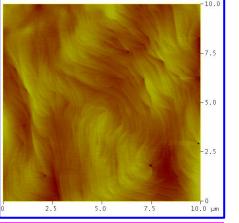
T_{growth} increases -

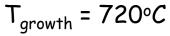
- mobility of Ga adatoms increases
- more smooth surface

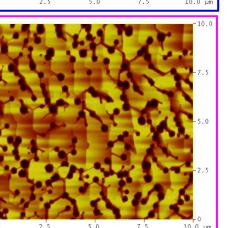






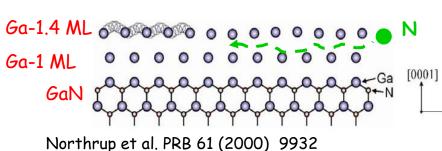




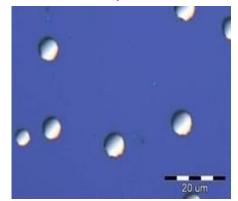


rms = 0.98 nm

 $rms = 18.3 \, nm$



Ga droplets

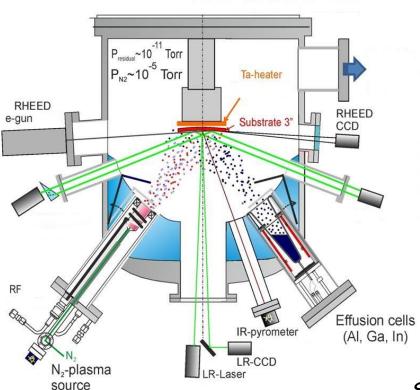


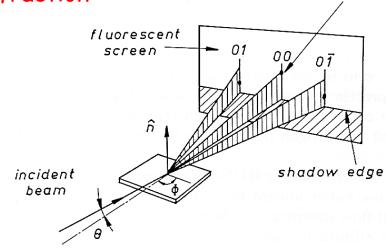
N species diffuse inside Ga-bilayer not on GaN surface

MBE of GaN - growth rate measurements



RHEED - Reflection High Energy Electron Diffraction



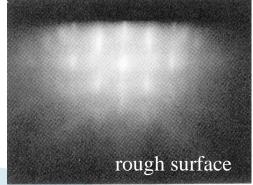


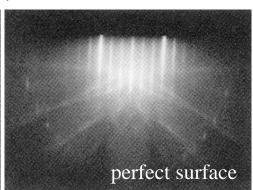
specular beam spot

RHEED commonly used to visualize:

- surface reconstruction
- quality of the surface (rough/smooth)
- ...

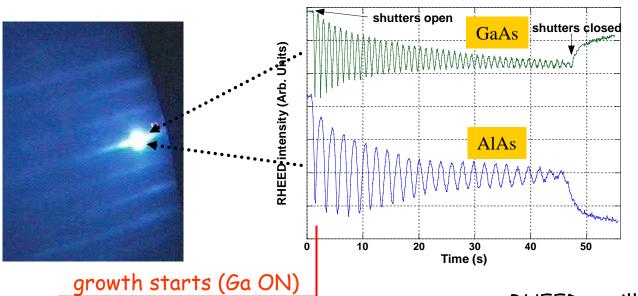
Si(001) RHEED patterns - sputter-cleaned surface





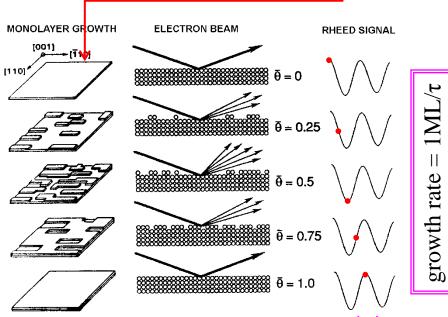
MBE of GaN - growth rate measurements



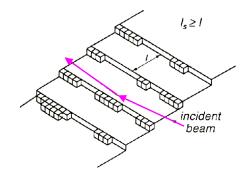


Ga - mobile; surface smooths when Ga off

Al - immobile; surface doesn't smooth when Al off



- RHEED oscillations periodic change of surface roughness
- observed for 2D nucleation (layer by layer growth)
- not observable for step flow growth

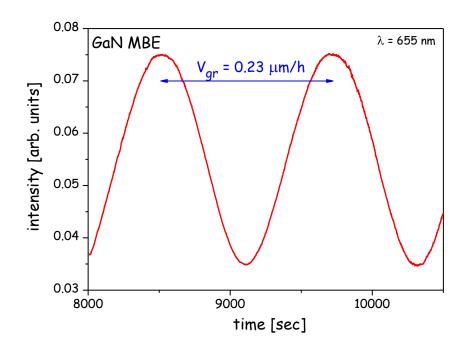


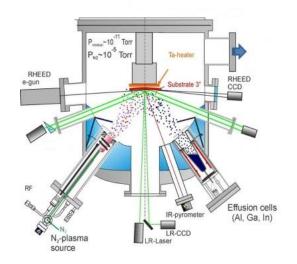
group V-rich conditions only

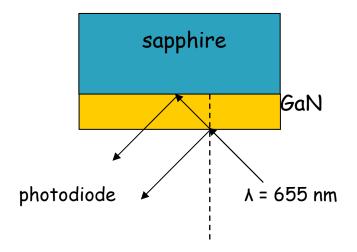
MBE of GaN - growth rate measurements



laser reflectometry



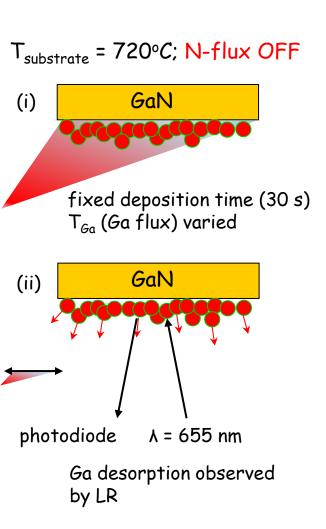


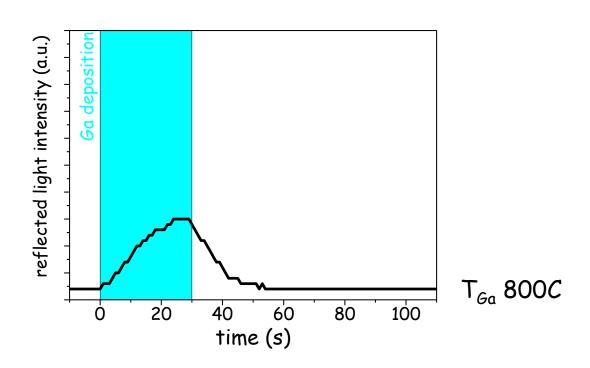


RHEED - measurement of "microscopic" growth rate LR - measurement of "macroscopic" growth rate

Simple Ga-desorption experiment; laser reflectometry

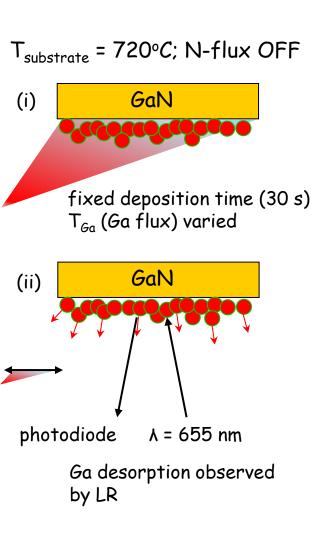


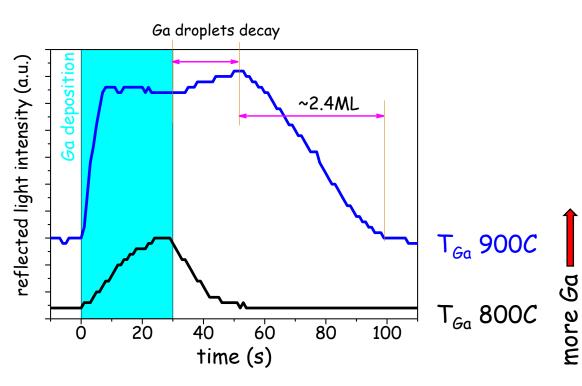




Simple Ga-desorption experiment; laser reflectometry

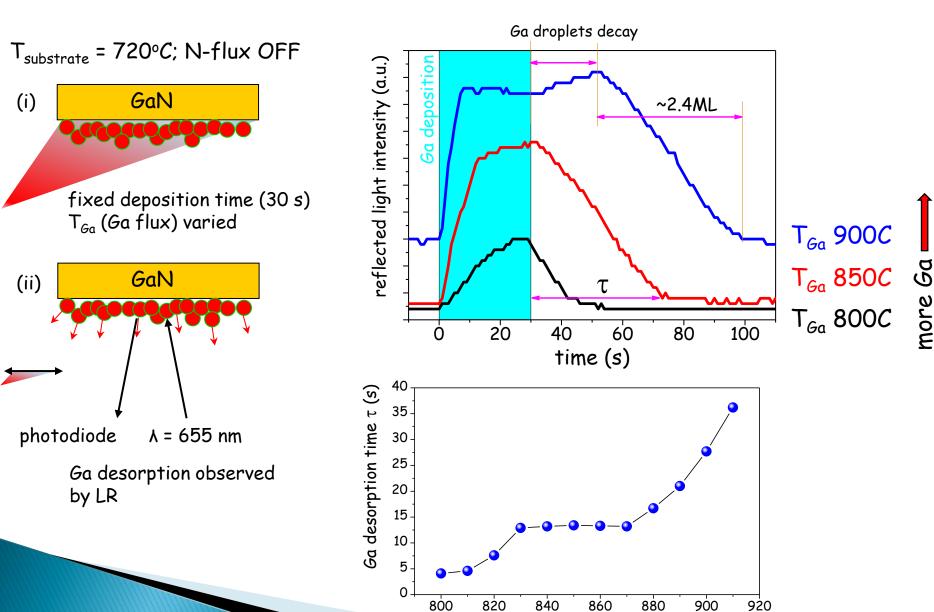






Simple Ga-desorption experiment; laser reflectometry

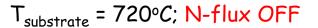


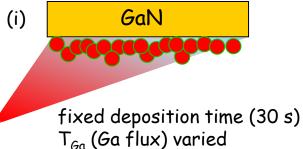


 $\mathsf{T}_{_{Ga}}(^{\circ}\mathcal{C})$

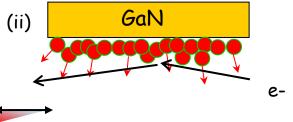
Simple Ga-desorption experiment; RHEED



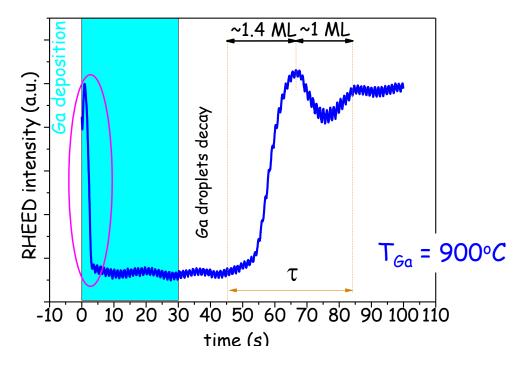


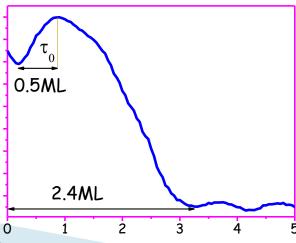


 T_{Ga} (Ga flux) varied



Ga desorption observed by RHEED

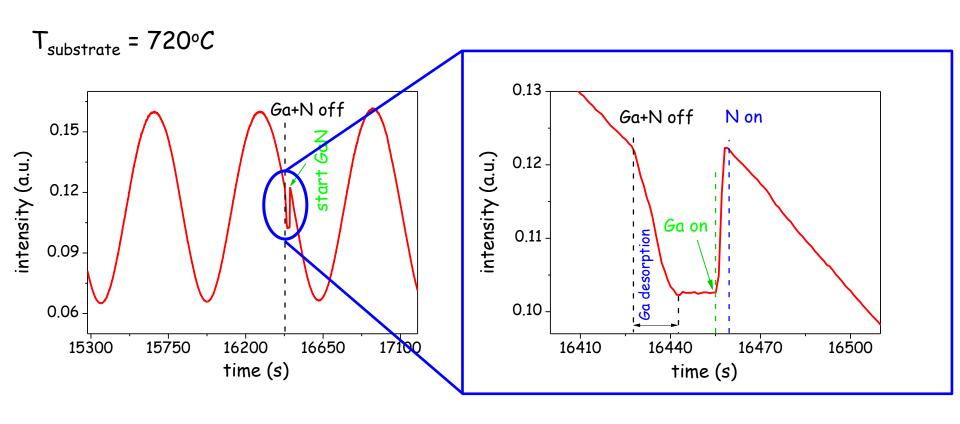




How to control amount of Ga during growth of GaN?



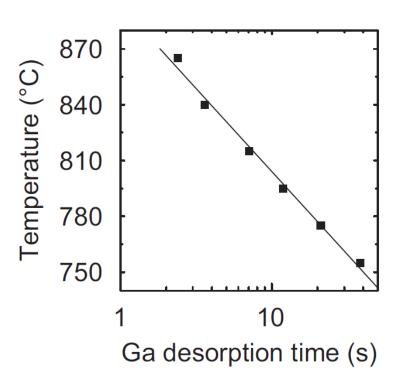
periodic growth interruptions for *in-situ* control of Ga-coverage



Ga flux slightly corrected (if needed) to keep 2ML of Ga on the surface

Ga desorption kinetics as surface thermometry





- R. Mata et al. JCG 334 (2011) 177
- 1. exposure of Si(111) to 0.4 ML/s Ga flux for 10 sec
- 2. RHEED used to measure recovery time of 7×7 Si(111) reconstruction

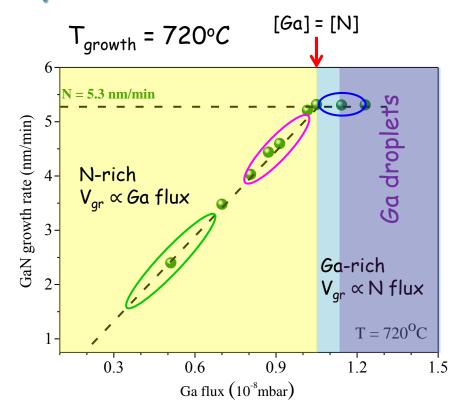
in reality:

- 1. RHEED signal decay measured vs. heater power
- 2. surface T measured by a thermocouple bonded to the substrate in order to convert heater power into surface T

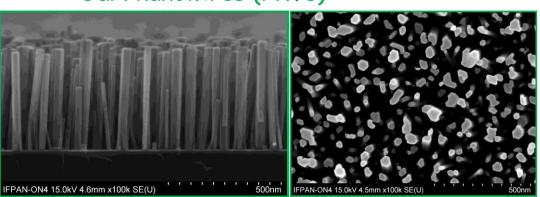
comments:

- 1. good tool to get run-to-run reproducibility of the surface substrate T (most important for grower)
- 2. absolute value of substrate surface T measured ???

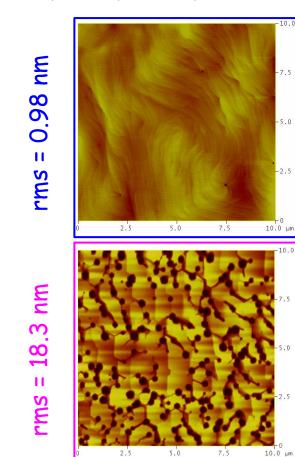




GaN nanowires (NWs)

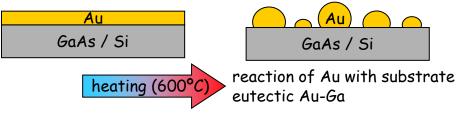


AFM image of epilayer surface $(10 \times 10 \mu m^2 \text{ area})$



Growth of NWs in vapor-liquid-solid (VLS) mode





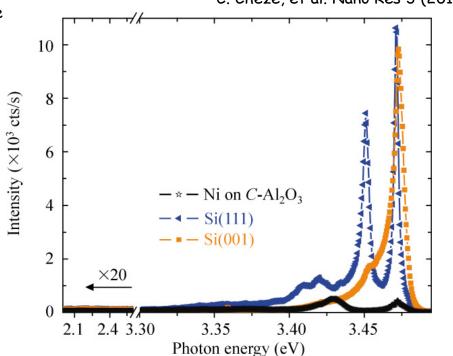
Molecular beams Zn (Cd) Te Hamiltonian Au Hamiltonian GaAs / Si

advantages:

- fast growth
- relative easy selective area growth
- size of droplet determines diameter of NW

Ni-assisted vs. catalyst-free GaN NWs



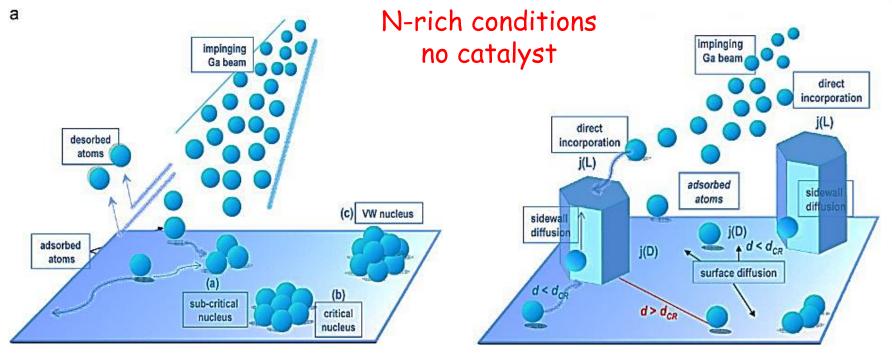


- D°X = 3.472 eV for all cases
 (typical for strain-free GaN layers)
- PL intensity much lower for GaN NWs grown with Ni - unintentional doping and more defects

much better optical properties of GaN NWs grown catalyst-free

How nanowires (NWs) do form?





Ristic et al. JCG 310 (2008)

Two steps in growth of NWs:

- self-induced nucleation (Volmer-Weber mechanism): Ga adatoms migrate on the surface or desorb until stable critical nuclei are formed
- 2. growth of NWs by incorporation of Ga atoms from substrate surface around NW and directly from the Ga beam

Our procedure of growth of GaN NWs on Si(111)

PAN

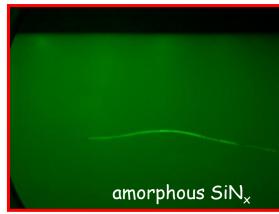
- Si-N bond 4.5 eV/bond (Ga-N bond: 2.17 eV/bond)
- competition of N bonding with Si and Ga; uncontrolled nitridation of the substrate

RHEED

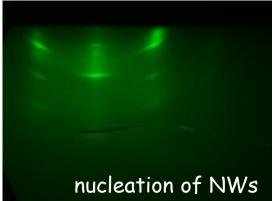
clean Si 7x7 reconstruction

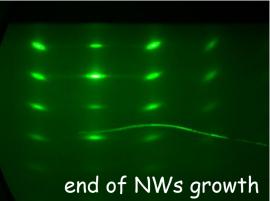
separate step of substrate nitridation



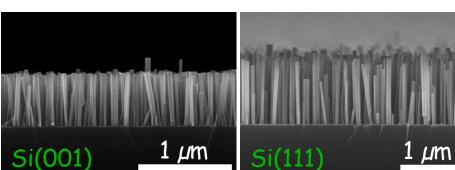


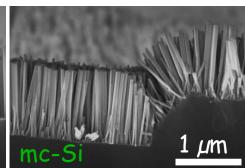
Ga+N on

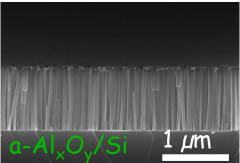






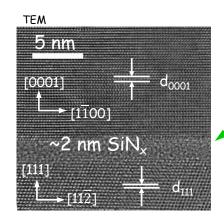


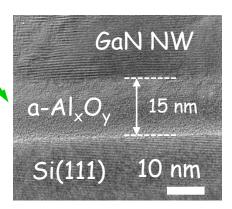


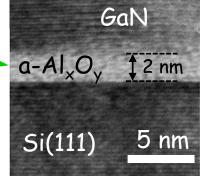


NWs always perpendicular to the surface of Si

(as opposed to VLS-grown NWs) amorphous layer between GaN and Si







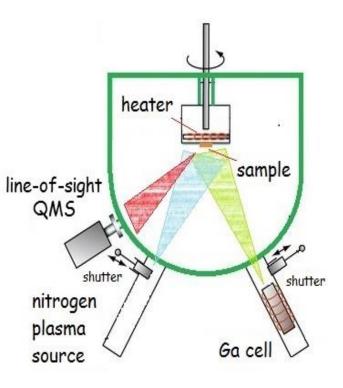
NW growth on $Si \equiv NW$ growth on amorphous layer

A. Wierzbicka et al. Nanotechnology 24 (2013) 035703 M. Sobanska et al. J. Cryst. Growth 401 (2014) 657-660 in-situ monitoring of NWs formation: QMS

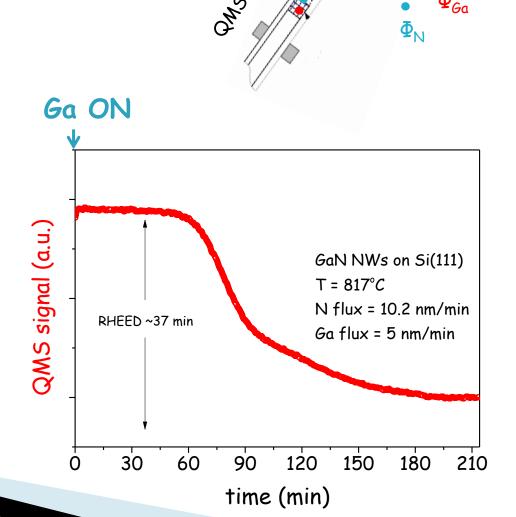
substrate

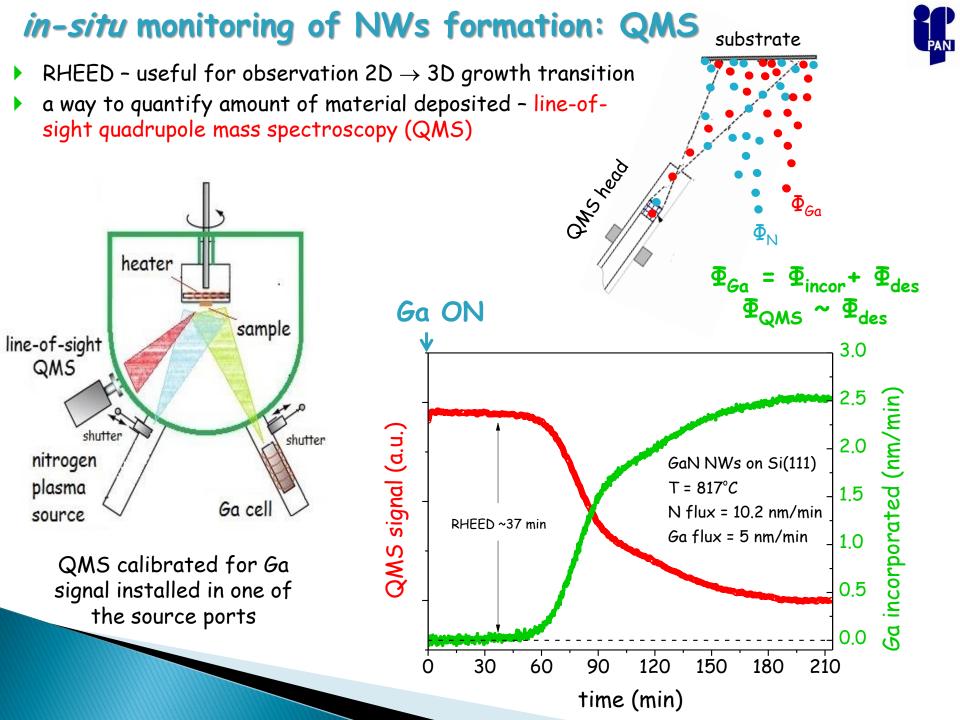
RHEED - useful for observation 2D ightarrow 3D growth transition

 a way to quantify amount of material deposited - line-ofsight quadrupole mass spectroscopy (QMS)

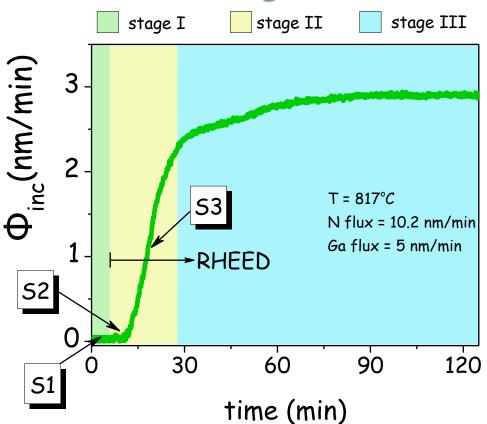


QMS calibrated for Ga signal installed in one of the source ports





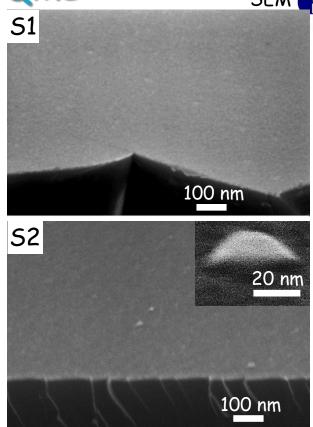
in-situ monitoring of NWs formation: QMS

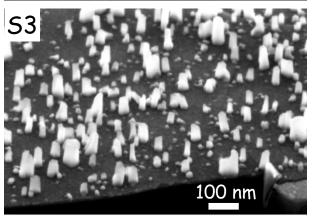


stage I: incubation period (no stable nuclei formed)

stage II: nucleation of GaN (creation of supercritical nuclei); density of stable nuclei increases

stage III: axial growth of NWs; density of NWs saturates; cooperative effects (exchange of Ga between neighboring NWs) lead to uniform lengths of NWs

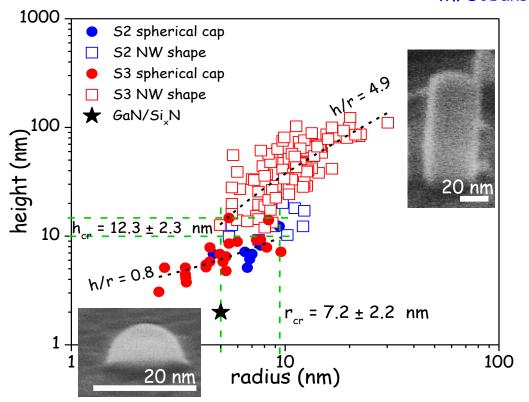




Transition from spherical cap to NW shape



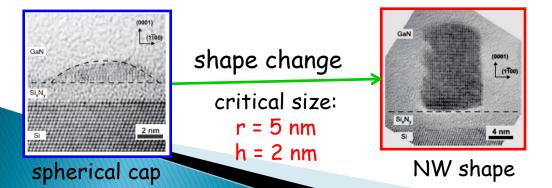
M. Sobanska et al. Nanotechnology 27 (2016) 325601



GaN NWs on $a-Al_xO_y$

critical size of shape change on a-Al_xO_y: $r = 7.2 \pm 2.2 \text{ nm}$ $h = 12.3 \pm 2.3 \text{ nm}$

larger critical size for shape transition on a-Al_xO_v that on Si



GaN NWs on nitridated Si

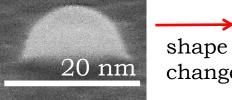
anisotropy of surface energy is the driving force for shape transition

V. Consonni et al. PRB 83 (2011)

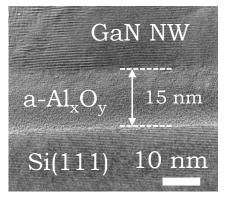
GaN NWs: non-crystalline vs. crystalline substrate

on a-Al_xO_v/Si

spherical cap



change



NW shape 20 nm

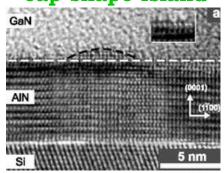
GaN weakly bonded to the substrate (very weak epitaxial constraints)

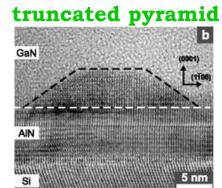
on AlN/Si

V. Consonni et al. PRB 81 (2010)

shape change

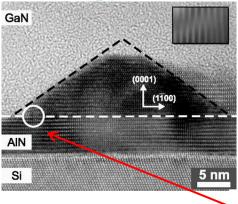
cap-shape island

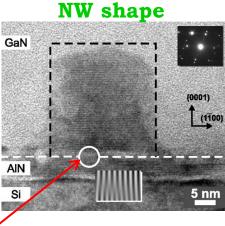




dislocation generation + shape change

full pyramid



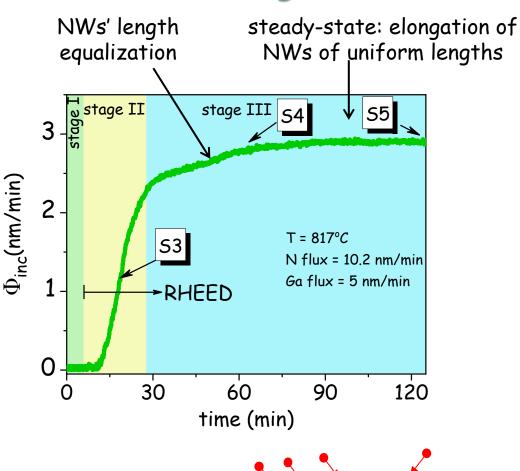


misfit dislocation

GaN strongly bonded to the substrate (strong epitaxial constraints)

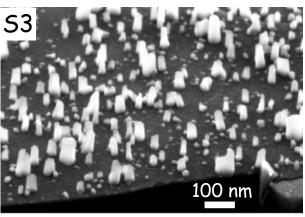
in-situ monitoring of NWs formation: QMS

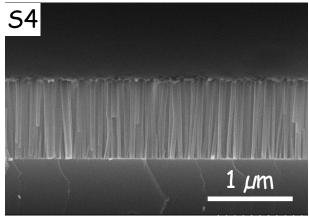




stage III

elongation period; density of NWs saturates; collective phenomena





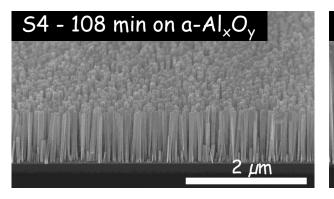
collective effects: exchange of Ga between NWs (desorption from sidewalls of longer NWs, capture by shorter ones) leading to uniform lengths of NWs

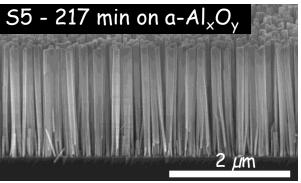
Sabelfeld et al. APL 103 (2013) 133105

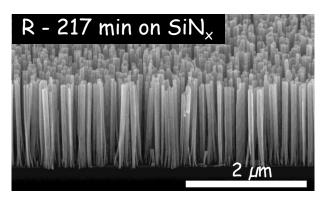
Growth of GaN NWs: N- or Ga-limited?



growth parameters: Φ_N = 10.2 nm/min; Φ_{Ga} = 5.0 nm/min







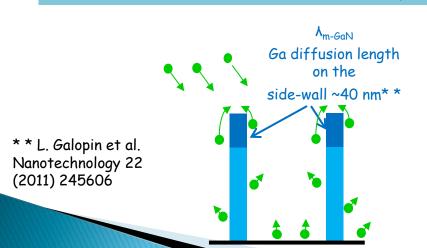
 $V_{qr} \sim 10.5 \pm 0.5 \text{ nm/min}$

 $V_{qr} \sim 10.3 \pm 0.5 \text{ nm/min}$

 $V_{qr} \sim 10.7 \pm 0.5 \text{ nm/min}$

\rightarrow growth rate limited by N flux

 \rightarrow the same conclusion reported for GaN NWs grown on Si(111)*



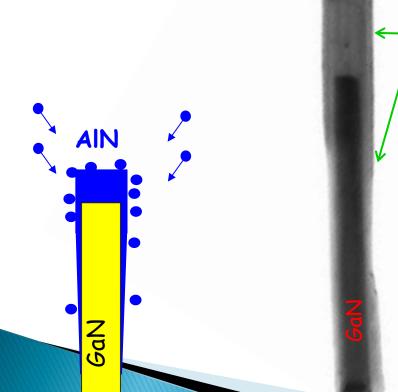
- *S. Fernández-Garrido, et al. Nano Lett. 15 (2015) 1930
- ▶ Ga adatoms being closer to the NW top than their diffusion length $\Lambda_{m\text{-}GaN}$ contribute to the axial growth
- locally Ga-rich conditions may be created at the NW top facet despite overall N-rich conditions
- at this stage diffusive Ga flux from the substrate not important

M. Sobanska et al. Nanotechnology 27 (2016) 325601

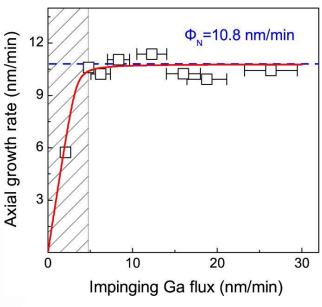
PAMBE growth of GCN NWs: N- or Ga-rich?

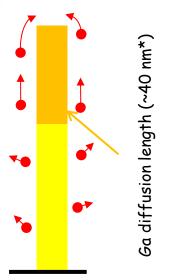


- Al much less mobile
- core-shell structures (AIN covers GaN, but NO GaN shell on AIN)



Fernandez-Garrido et al. Nano Lett 13 (2013) 3274





- overall N-rich conditions
- locally (at the NW top facet) Ga-rich conditions due to diffusion of Ga along the NW sidewalls

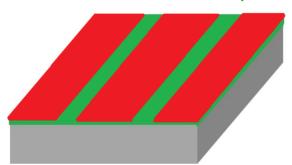
Selective area growth (SAG) of GaN NWs



disadvantages of self-assembled NW growth:

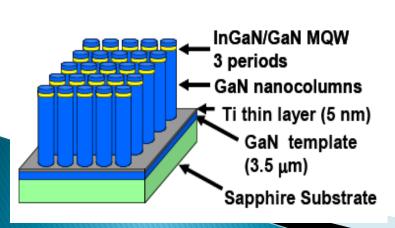
- 1. control of NW density difficult
 - easier in VLS growth mode if positions of Au (or Ga) droplets from which NW grow can be ordered
- 2. random positions of the NWs on the substrate (due to a random nature of the nucleation process)

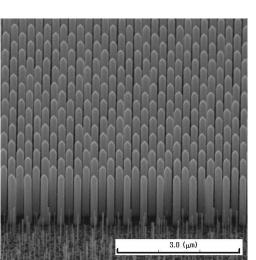
mask nucleation layer



in SAG:

- masked substrate with a pattern created (by lithography and etching) to open the mask-free areas with exposed nucleation layer
- growth conditions needed to nucleate NWs in the openings in the mask, while nucleation on the mask surface is prohibited
- proper choice of substrate and mask material needed



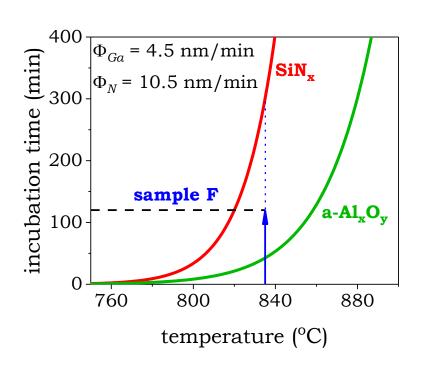


H. Sekiguchi et al., IWNS 2008 Montreux, Switzerland

How to adjust the growth conditions for SAG?



study nucleation kinetics of NWs on various materials to find the best suitable mask/substrate pair



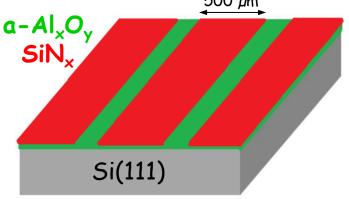
on
$$a-Al_xO_y/Si$$
 $T_{gr} = 835^{\circ}C$
 $t_{inc} = 42 \text{ min}$

on SiN_x/Si
$$T_{gr} = 835^{\circ}C$$

$$t_{inc} = 295 \text{ min}$$

 \rightarrow much more efficient nucleation of GaN NWs on a-Al_xO_y than on SiN_x

Growth of GaN on Si with SiN_x mask and a-Al_xO_y stripes

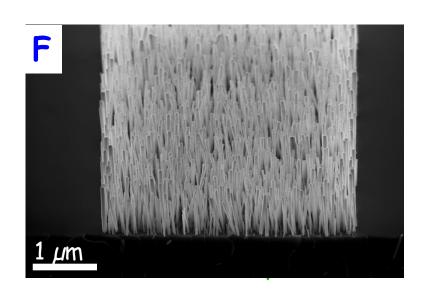


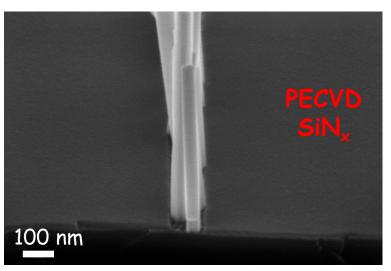
Si substrates covered by 15 nm thick a-Al_xO_y film deposited at low temperature by ALD



- ~15 nm thick SiN_x deposited by PECVD @ T = $300^{\circ}C$
- e-beam lithography + RIE etching to open windows in the SiN, mask

$$T_{gr} = 835$$
°C; $t_{gr} = 120 \text{ min}$

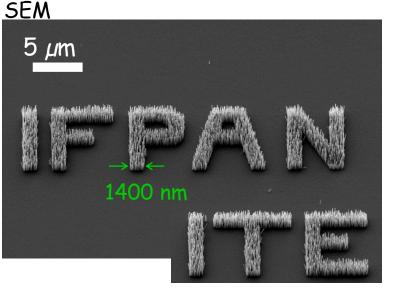


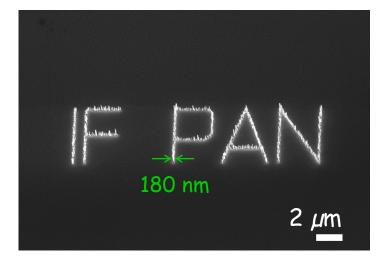


pure Selective Area Growth in the SiN_x/a-Al_xO_v system

- GaN NWs formed selectively on a-Al_xO_y stripes
- no GaN nucleation on SiN_x

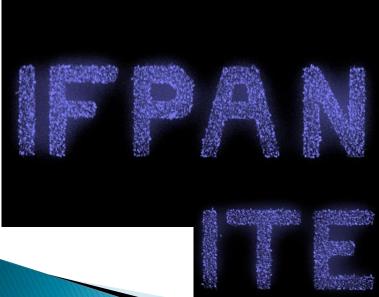
Some results of GaN NW SAG growth experiments

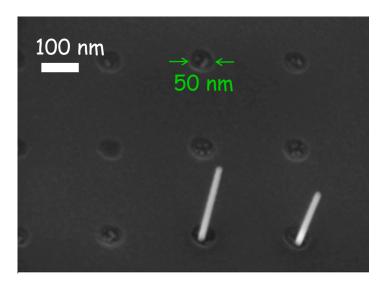








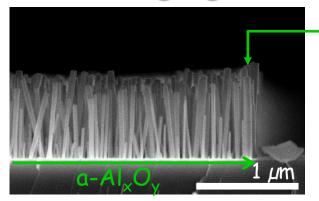




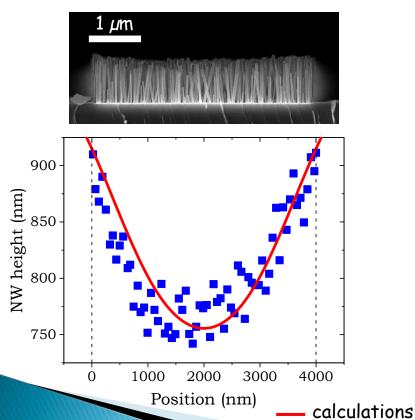
- yield on e-beam processed substrate still too low
- processing of the substrates by e-beam lithography and RIE etching must be improved

... and edge growth in SAG



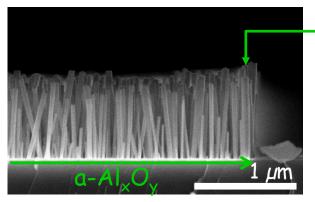


longer GaN NWs close to the edge of the stripe

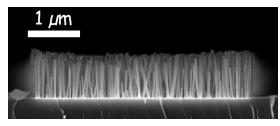


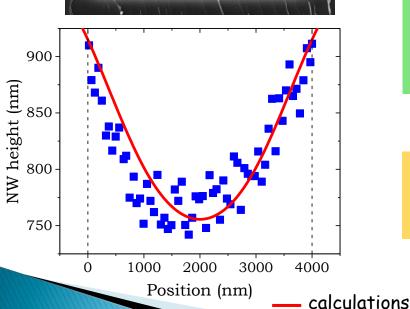
Surface Ga diffusion and edge growth in SAG

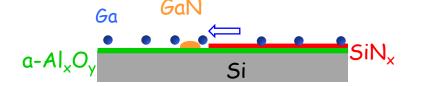




longer GaN NWs close to the edge of the stripe





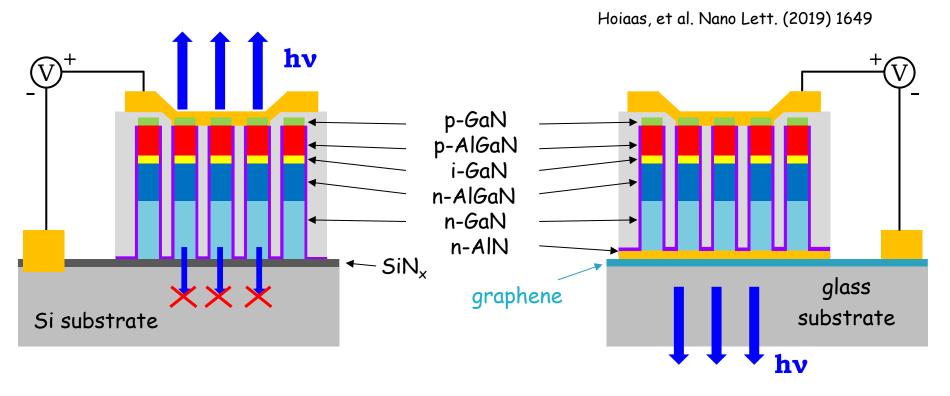


Ga diffuses into the a- Al_xO_y stripe during NW nucleation period \rightarrow faster GaN growth during nucleation stage \rightarrow longer NWs close to the edge of the a- Al_xO_y stripe

general comment: nucleation kinetics in SAG depends on the size of the substrate pattern due to significant surface diffusion of adatoms

NW LED design



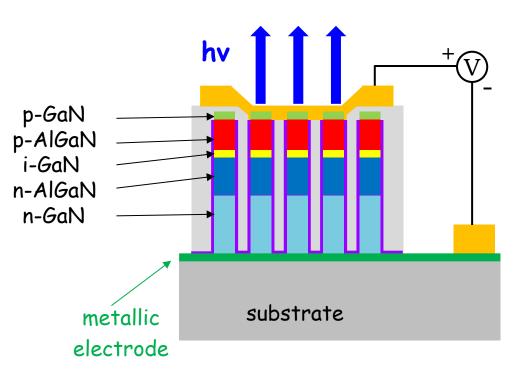


- part of emitted light lost by absorption in the substrate
- nonlinear electrical GaN/SiN_x/Si junction

- graphene transfer from the host substrate complicated; small area single cm²
- nucleation on graphene very difficult
- AIN nucleation layer needed high series resistance

NW LED with bottom electrode

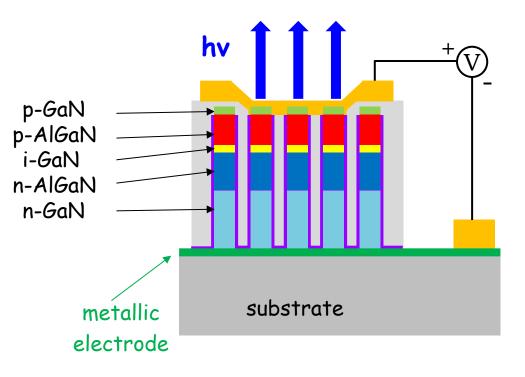




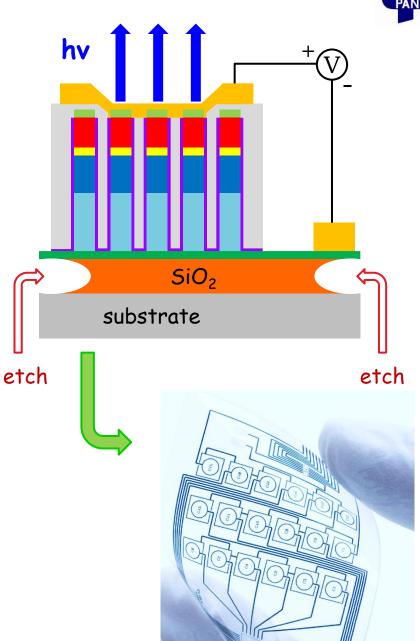
- high electrical conductivity and ohmic contact to GaN required
- high optical reflectivity desirable
- stable at MBE growth conditions
- pure metals (W, Mo, Ti, ...) react with Ga
- ZrN, TiN, ...

NW LED with bottom electrode - flexible electronics





- high electrical conductivity and ohmic contact to GaN required
- high optical reflectivity desirable
- stable at MBE growth conditions
- **...**



buhlergroup.com

Conclusion



in-situ observation of the growth interface is crucial for understanding the growth processes and finding efficient ways of their control

Many thanks to my co-workers

dr Marta Sobańska



dr Ola Wierzbicka



mgr Kamil Kłosek



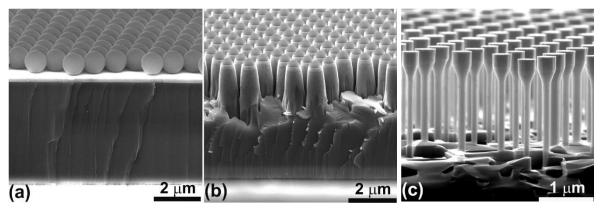
mgr Giorgi Tchutchulashvili

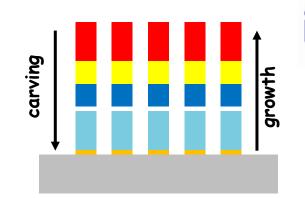


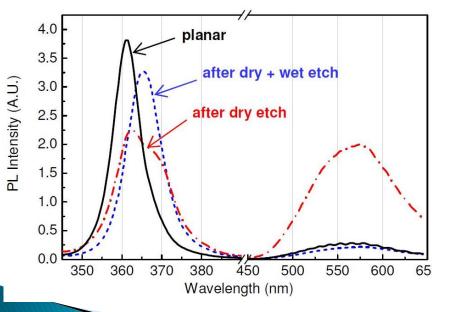
and many others ...

Top-down or bottom-up (growth)?

Q. Li, et al. Optics Expr. 19 (2011)



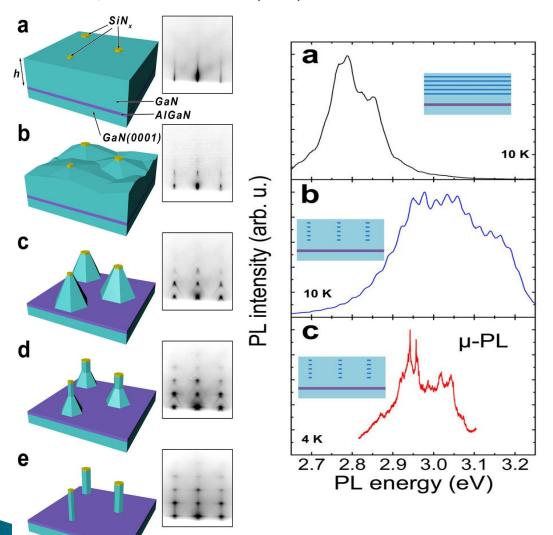


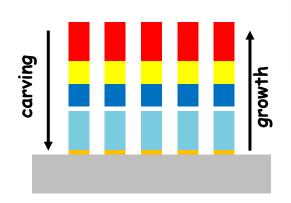


- planar epitaxial growth of p-GaN/n-GaN
- 2. 1 µm diameter silica spheres mask
- 3. plasma etching (b)
- very long wet etching in KOH-based solution
- significant damage after RIE (strong YL luminescence)
- PL redshift due to strain release
- wet etching rate dependent on composition

Top-down or bottom-up (growth)?

B. Damiliano, et al. Nano Lett. 16 (2016) 1863





- planar epitaxial growth of GaN/InGaN
- 2. SiN mask deposition (in-situ)
- Selective Area Sublimation
 900°C (b e)

- high-quality planar growth still required
- In-Ga interdiffusion during the SAS process
- role of threading dislocations?
 only a few % of NWs with TDs (geometrical factor)

